



# SPN8836

## N-Channel Enhancement Mode MOSFET

### DESCRIPTION

The SPN8836 is the N-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology. The SPN8836 has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low RDS(ON) and fast switching speed.

### FEATURES

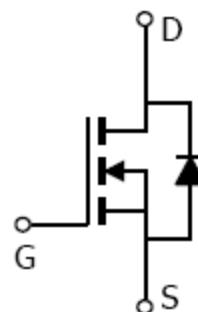
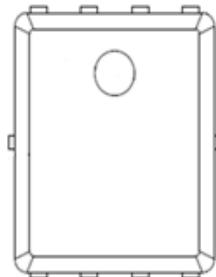
- ◆ 30V/80A,RDS(ON)=6.0mΩ@V<sub>GS</sub>=10V
- ◆ 30V/80A,RDS(ON)=9.0mΩ@V<sub>GS</sub>=4.5V
- ◆ Super high density cell design for extremely low RDS (ON)
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ PPAK5x6-8L package design

### APPLICATIONS

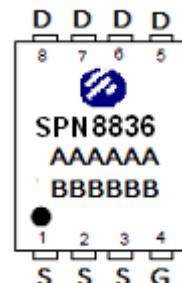
- High Frequency Synchronous Buck Converter
- DC/DC Power System
- Load Switch

### PIN CONFIGURATION

PPAK5x6-8L



### PART MARKING



A : Lot Code  
B : Date Code  
(YY / MM / DD)



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### PPAK5x6-8L PIN DESCRIPTION

Pin	Symbol	Description
1	S	Source
2	S	Source
3	S	Source
4	G	Gate
5	D	Drain
6	D	Drain
7	D	Drain
8	D	Drain

### ORDERING INFORMATION

Part Number	Package	Part Marking
SPN8836DN8RGB	PPAK5x6-8L	SPN8836

※ SPN8836DN8RGB : Tape Reel ; Pb – Free ; Halogen - Free

### ABSOLUTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V <sub>DSS</sub>	30	V
Gate –Source Voltage	V <sub>GSS</sub>	±20	V
Continuous Drain Current(Silicon Limited)	T <sub>C</sub> =25°C	80	A
	T <sub>C</sub> =100°C	57	
Pulsed Drain Current	I <sub>DM</sub>	160	A
Avalanche Current	I <sub>AS</sub>	50	A
Single Pulse Avalanche Energy	E <sub>AS</sub>	180	mJ
Power Dissipation	T <sub>C</sub> =25°C	P <sub>D</sub>	W
Operating Junction Temperature		T <sub>J</sub>	150
Storage Temperature Range	T <sub>STG</sub>	-55/150	°C
Thermal Resistance-Junction to Case	R <sub>θJC</sub>	1.5	°C/W



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### ELECTRICAL CHARACTERISTICS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> =0V, ID=250uA	30			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>Ds</sub> =V <sub>GS</sub> , ID=250uA	1.0		2.5	
Gate Leakage Current	I <sub>GSS</sub>	V <sub>Ds</sub> =0V, V <sub>GS</sub> =±20V			±100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>Ds</sub> =24V, V <sub>GS</sub> =0V			1	uA
		V <sub>Ds</sub> =24V, V <sub>GS</sub> =0V, T <sub>J</sub> =55°C			5	
On-State Drain Current	I <sub>D(on)</sub>	V <sub>Ds</sub> ≥5V, V <sub>GS</sub> =10V			80	A
Drain-Source On-Resistance	R <sub>Ds(on)</sub>	V <sub>GS</sub> =10V, ID=20A		4.7	6.0	mΩ
		V <sub>GS</sub> =4.5V, ID=10A		6.5	9.0	
Forward Transconductance	g <sub>fs</sub>	V <sub>Ds</sub> =5V, ID=30A		22		S
Diode Forward Voltage	V <sub>SD</sub>	I <sub>s</sub> =1A, V <sub>GS</sub> =0V			1	V
<b>Dynamic</b>						
Total Gate Charge	Q <sub>g</sub>	V <sub>Ds</sub> =15V, V <sub>GS</sub> =4.5V ID= 15A		20	18	nC
Gate-Source Charge	Q <sub>gs</sub>			7.6		
Gate-Drain Charge	Q <sub>gd</sub>			7.2		
Input Capacitance	C <sub>iss</sub>	V <sub>Ds</sub> =15V, V <sub>GS</sub> =0V f=1MHz		2300		pF
Output Capacitance	C <sub>oss</sub>			265		
Reverse Transfer Capacitance	C <sub>rss</sub>			210		
Turn-On Time	t <sub>d(on)</sub>	V <sub>DD</sub> =15V, ID=15A, V <sub>GEN</sub> =10V R <sub>G</sub> =3.3Ω		7.8	15	nS
	t <sub>r</sub>			15	12	
Turn-Off Time	t <sub>d(off)</sub>			37	30	
	t <sub>f</sub>			10.6	15	



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## TYPICAL CHARACTERISTICS

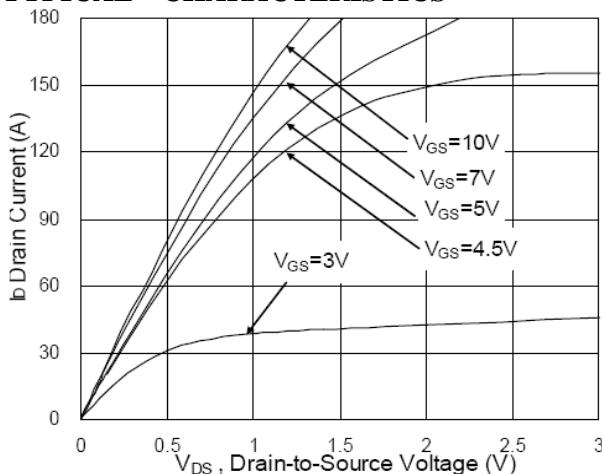


Fig. 1 Typical Output Characteristics

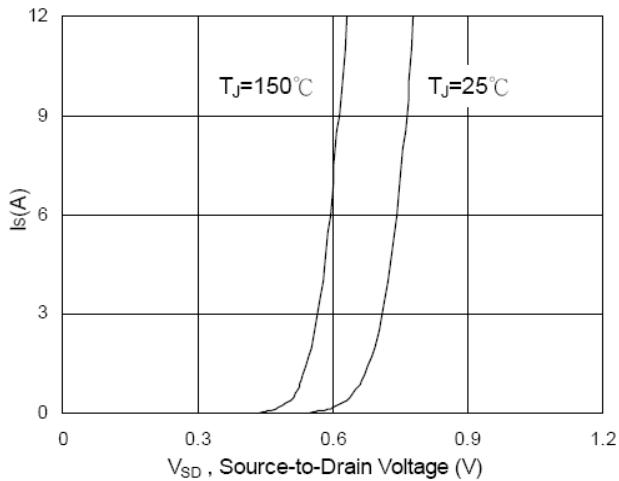


Fig. 2 Transfer Characteristics

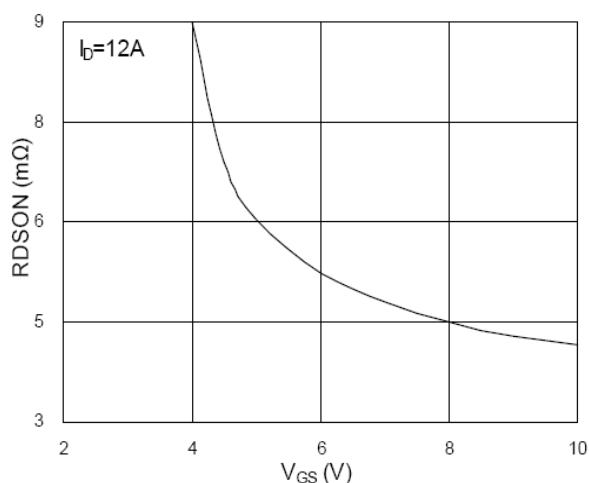


Fig. 3 On-Resistance vs Gate voltage

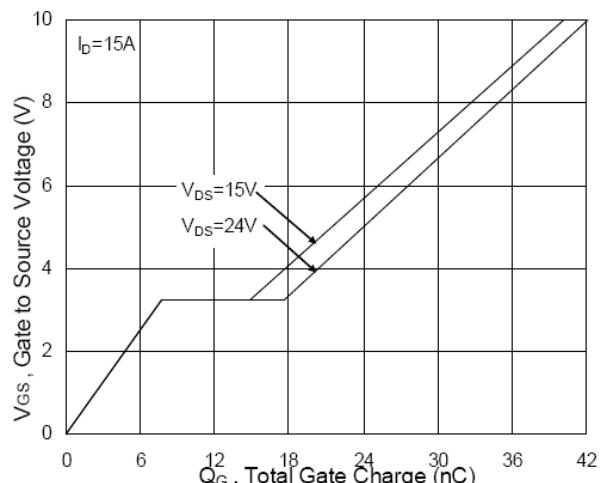


Fig. 4 Gate Charge Characteristics

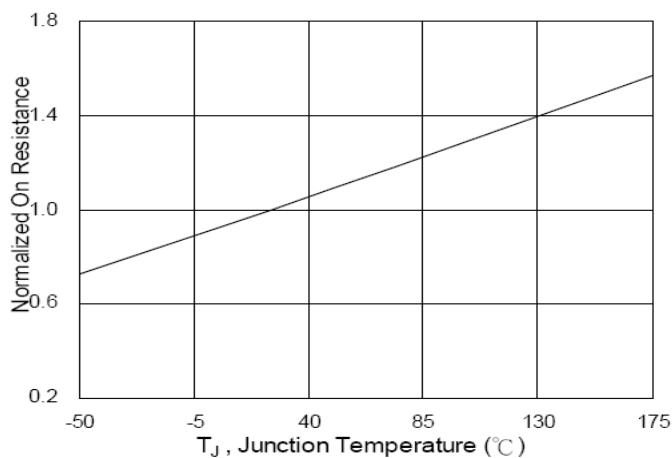


Fig. 5 On-Resistance vs Junction Temp

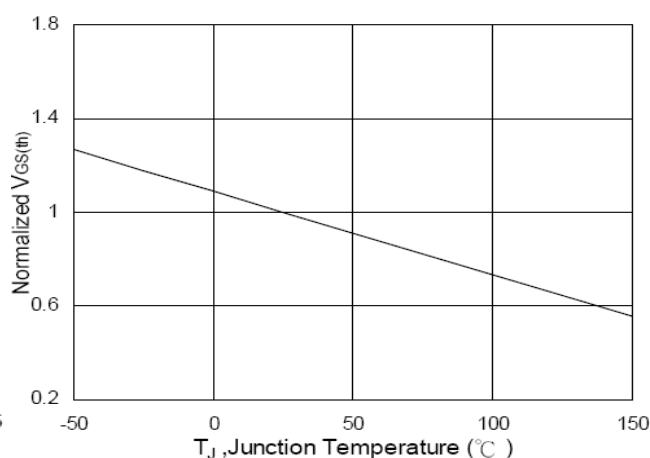


Fig. 6  $V_{GS}$  vs Junction Temperature



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### TYPICAL CHARACTERISTICS

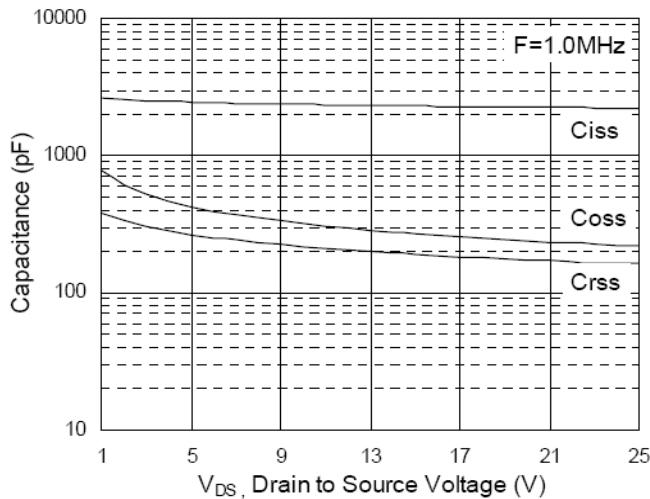


Fig. 7 Typical Capacitance Characteristics

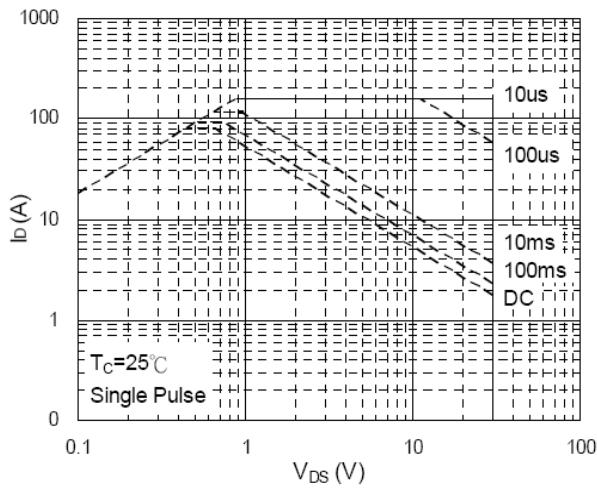


Fig. 8 Maximum Safe Operation Area

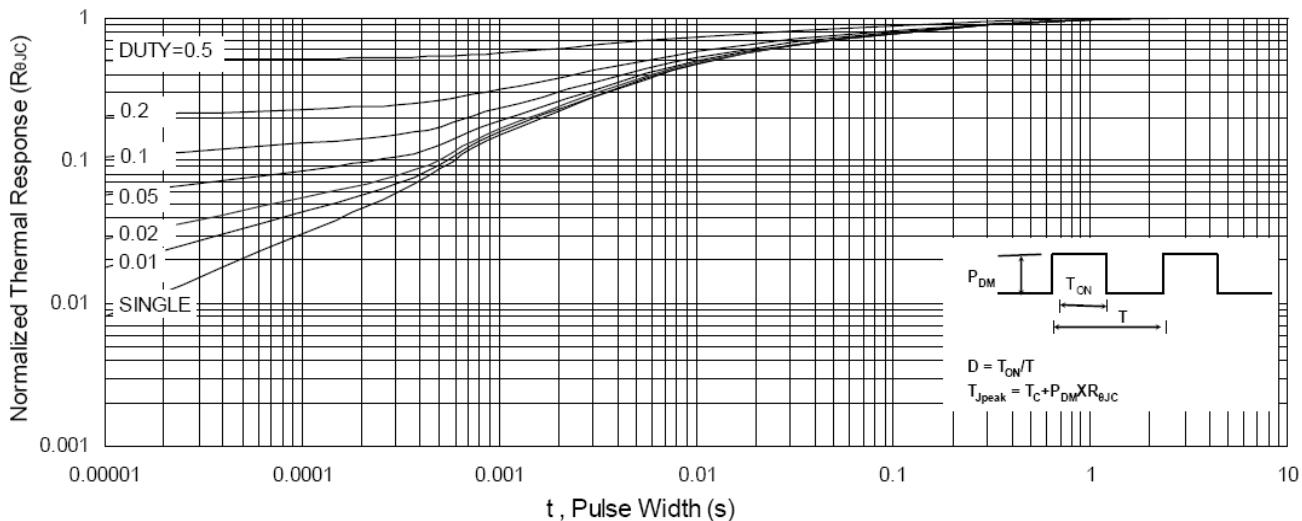


Fig. 9 Effective Transient Thermal Impedance

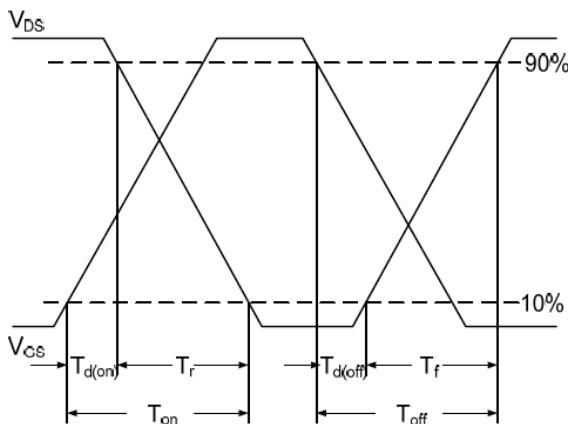


Fig. 10 Switching Time Waveform

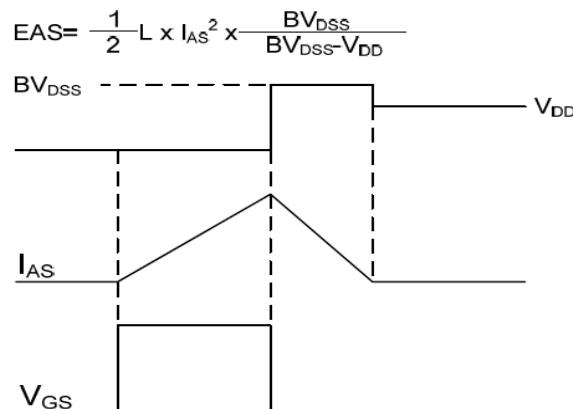


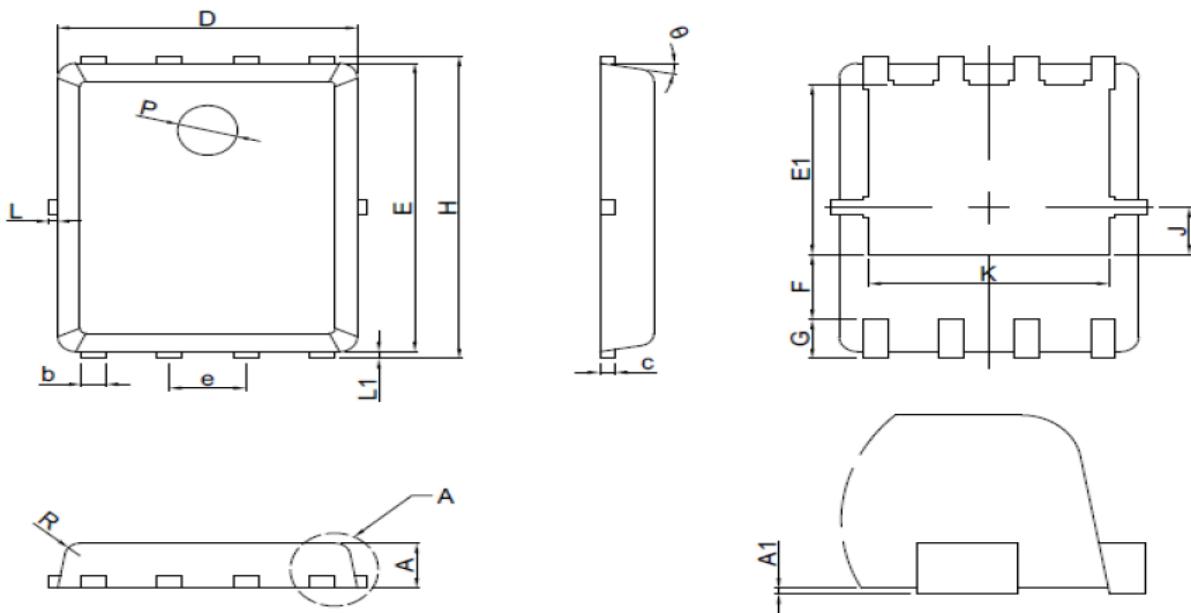
Fig. 11 Unclamped Inductive Waveform



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### PPAK5x6-8L PACKAGE OUTLINE



SYMBOL	MILLIMETERS		
	MIN	NOM	MAX
A	0.8	0.95	1.1
A1	0.00	0.03	0.05
b	0.33	0.41	0.51
c	0.254 REF		
D	4.80	4.95	5.10
F	1.40 REF		
E	5.70	5.80	5.90
e	1.27 BSC		
H	5.90	6.05	6.20
L1	0.06	0.13	0.20
G	0.60 REF		
J	0.95 BSC		
K	4.00 REF		
L	---	----	0.20
P	1.00 REF		
E1	3.40REF		
E2	0.95 REF		
θ	6°	10°	14°
R	0.25REF		



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